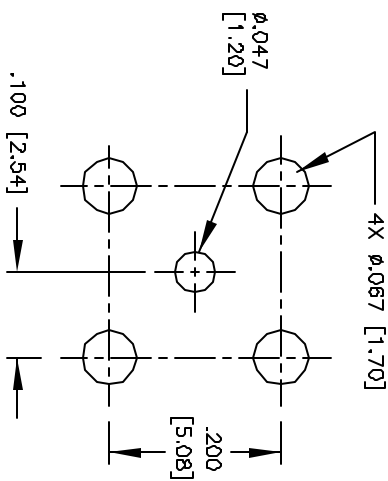
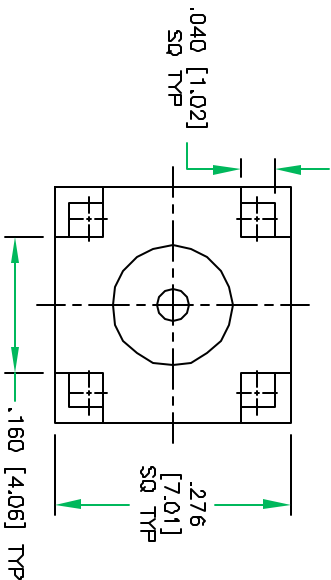
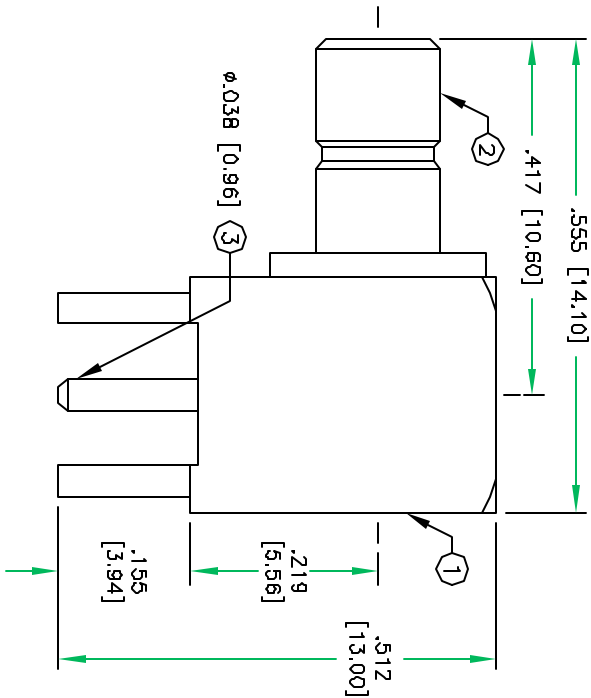


REVISIONS		DOC. NO.	SPC-F005, Total Pages: 2					
DCP #	REV	DESCRIPTION	DATE	CHECKED	DATE	APPRVD	DATE	
129	A	RELEASED	D.J.C.	1/19/98	J.C.	3/13/98	JMM	7/7/98



SUGGESTED MOUNTING CONFIGURATION

**SPECIFICATIONS:**

IMPEDANCE: 50 OHMS

ITEM	DESCRIPTION	QTY	MATERIAL	FINISH
5	DIELECTRIC	1	TEFLON	NONE
4	DIELECTRIC	1	TEFLON	NONE
3	PIN	1	BRASS	GOLD
2	PRESS FIT BODY	1	BRASS	NICKEL
1	BODY	1	BRASS	NICKEL

**DISCLAIMER**  
 ALL STATEMENTS AND TECHNICAL INFORMATION CONTAINED HEREIN ARE BASED UPON INFORMATION AND/OR TESTS WE BELIEVE TO BE ACCURATE AND RELIABLE. SINCE CONDITIONS OF USE ARE BEYOND OUR CONTROL, THE USER SHALL DETERMINE THE SUITABILITY OF THE PRODUCT FOR THE INTENDED USE AND ASSUME ALL RISK AND LIABILITY WHATSOEVER IN CONNECTION THEREWITH.



**SPC TECHNOLOGY**

UNLESS OTHERWISE SPECIFIED, DIMENSIONS ARE FOR REFERENCE PURPOSES ONLY.

DRAWN BY:	DANIEL CAREY	DATE:	1/19/98
CHECKED BY:	JOHN COLE	DATE:	3/13/98
APPROVED BY:	JEFF MCVICKER	DATE:	7/7/98

DRAWING TITLE:		SMB R/A PCB MOUNT JACK	
SIZE	DWG. NO.	ELECTRONIC FILE	REV
A	1524	92N3370.DWG	A
SCALE:	NTS	U.O.M.: INCHES [mm]	SHEET: 1 OF 1